



#### DMT6002LPS

#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET** PowerDI5060-8 (Type K)

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> Max	I <sub>D</sub> Max T <sub>C</sub> = +25°C (Note 9)
60V	$2m\Omega$ @ $V_{GS} = 10V$	100A
	$3m\Omega$ @ $V_{GS} = 6V$	100A

#### **Features**

- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Thermally Efficient Package Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (RDS(ON)), yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Switching
- Synchronous Rectification
- **DC-DC Converters**

#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>5060-8 (Type K)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

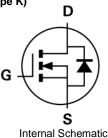
# PowerDI5060-8 (Type K)

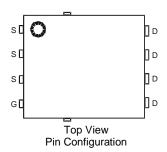


Top View



Pin1 **Bottom View** 





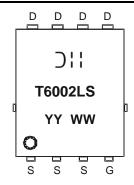
## **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMT6002LPS-13	PowerDI5060-8 (Type K)	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website athttps://www.diodes.com/design/support/packaging/diodes-packaging/

## **Marking Information**



☐ ! = Manufacturer's Marking T6002LS = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)



## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	60	V	
Gate-Source Voltage		$V_{GSS}$	±20	V
Continuous Drain Current V 40V (Notes 6.8.0)	T <sub>C</sub> = +25°C	I <sub>D</sub>	100	A
Continuous Drain Current, V <sub>GS</sub> = 10V (Notes 6 & 9)	$T_C = +70$ °C		100	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	400	Α
Continuous Body Diode Forward Current (Note 6)	T <sub>C</sub> = +25°C	I <sub>S</sub>	100	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	400	Α
Avalanche Current, L = 3mH		I <sub>AS</sub>	14	Α
Avalanche Energy, L = 3mH		E <sub>AS</sub>	294	mJ

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	P <sub>D</sub>	2.3	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	55	°C/W
Total Power Dissipation (Note 6)	P <sub>D</sub>	167	W
Thermal Resistance, Junction to Case (Note 6)	R <sub>eJC</sub>	0.9	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

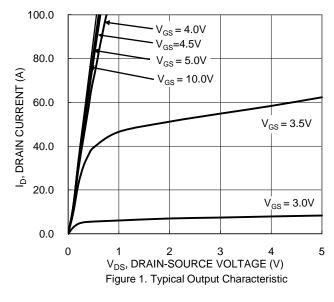
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	$BV_{DSS}$	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	I	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)						•	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1	_	3	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	1.5	2	mΩ	$V_{GS} = 10V, I_D = 50A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>		2.2	3	11112	$V_{GS} = 6V, I_D = 50A$	
Diode Forward Voltage	V <sub>SD</sub>		_	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 50A	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	Ciss	_	6555	_		$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Output Capacitance	Coss	_	2264	_	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	_	187	_			
Gate Resistance	$R_g$	_	0.7	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	$Q_g$	_	130.8	_		V <sub>DS</sub> = 30V, I <sub>D</sub> = 50A	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	63.6	_	nC		
Gate-Source Charge	Qgs	-	20.8	_	IIC		
Gate-Drain Charge	$Q_{gd}$	-	29.4	_			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	11.2	_		$V_{DD} = 20V, V_{GS} = 10V,$ $I_{D} = 50A, R_{q} = 2.5\Omega$	
Turn-On Rise Time	t <sub>R</sub>		10.8	_			
Turn-Off Delay Time	t <sub>D(OFF)</sub>		44	_	ns		
Turn-Off Fall Time	t <sub>F</sub>		19.5	_	1		
Reverse Recovery Time	t <sub>RR</sub>	_	61.8	_	ns	I 504 41/44 4004/	
Reverse Recovery Charge	Q <sub>RR</sub>	_	123	_	nC	$I_F = 50A$ , di/dt = 100A/ $\mu$ s	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Short duration pulse test used to minimize self-heating effect.
- Guaranteed by design. Not subject to product testing.
   Package limited.





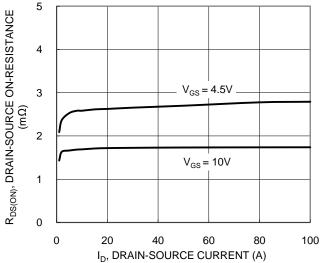


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

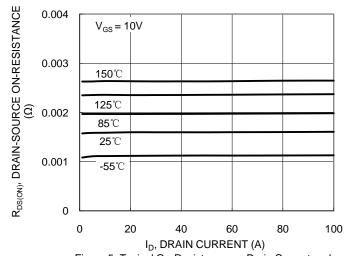
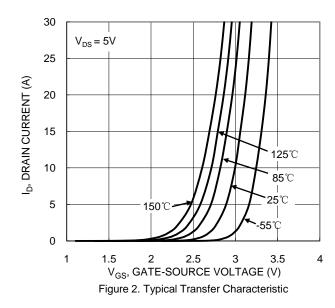
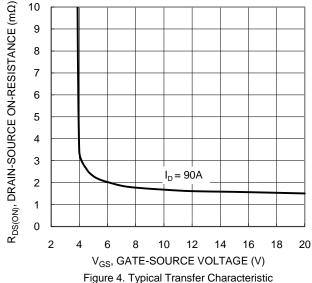


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





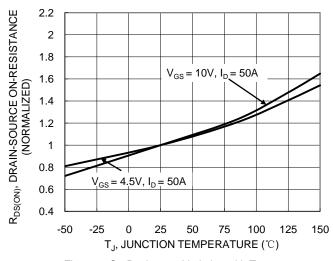


Figure 6. On-Resistance Variation with Temperature





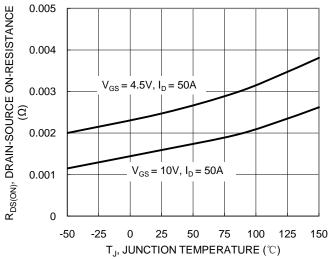


Figure 7. On-Resistance Variation with Temperature

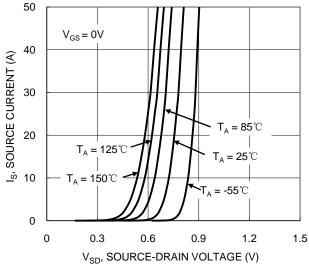
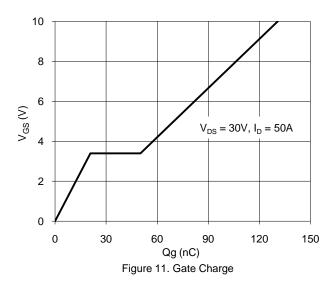


Figure 9. Diode Forward Voltage vs. Current



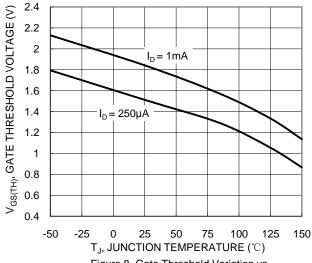


Figure 8. Gate Threshold Variation vs. JunctionTemperature

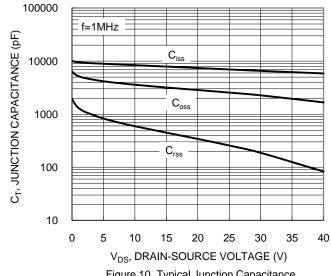
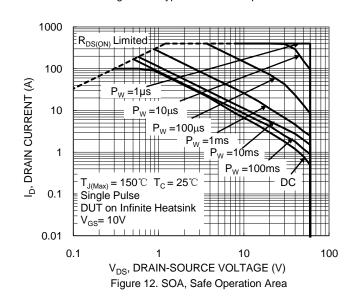


Figure 10. Typical Junction Capacitance





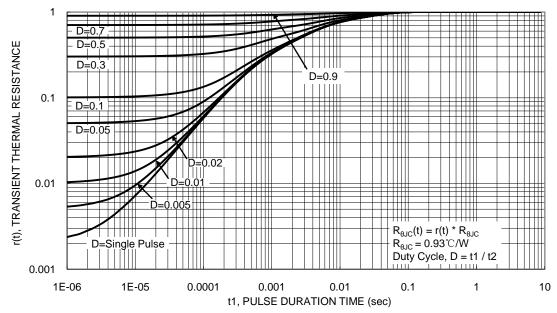


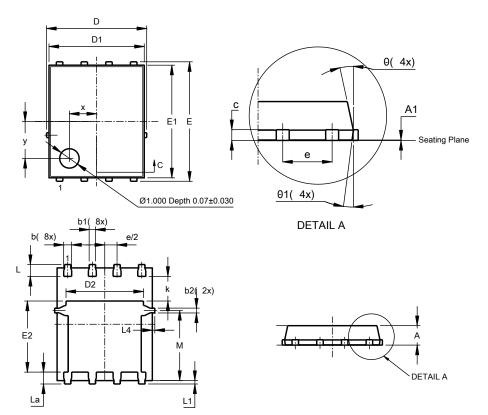
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8 (Type K)

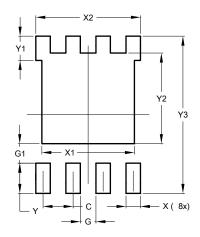


PowerDI5060-8 (Type K)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05	0.02	
b	0.33	0.51	0.41	
b1	0.300	0.366	0.333	
b2	0.20	0.35	0.25	
C D	0.23	0.33	0.277	
	5	.15 BS0		
D1	4.85	4.95	4.90	
D2	-	-	3.98	
Е		.15 BS0	$\sim$	
E1	5.75	5.85	5.80	
E2	3.56	3.725	3.66	
е	1	.27BSC		
k	-	-	1.27	
L	0.51	0.71	0.61	
La	0.51	0.675	0.61	
L1	0.05	0.20	0.175	
L4	-	-	0.125	
М	3.50	3.71	3.605	
X	-	-	1.400	
у	-	-	1.900	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8 (Type K)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	3.910		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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